

**Vishay Siliconix** 

# **Bi-Directional P-Channel 20-V (D-S) MOSFET**

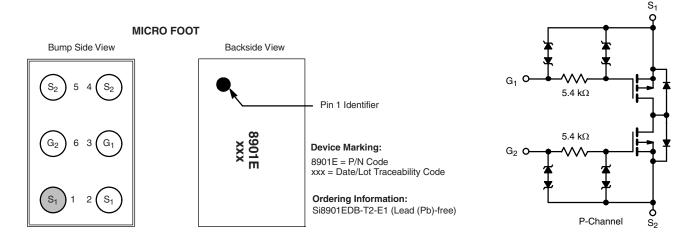
PRODUCT SUMMARY					
V <sub>S1S2</sub> (V)	<b>R<sub>S1S2(on)</sub> (</b> Ω)	I <sub>S1S2</sub> (A)			
	0.060 at V <sub>GS</sub> = - 4.5 V	- 4.4			
- 20	0.080 at V <sub>GS</sub> = - 2.5 V	- 3.9			
	0.105 at V <sub>GS</sub> = - 1.8 V	- 3.4			

### FEATURES

- TrenchFET<sup>®</sup> Power MOSFET
- Ultra-Low R<sub>SS(on)</sub>
- ESD Protected: 6000 V
- MICRO FOOT<sup>®</sup> Chipscale Packaging Reduces Footprint Area, Profile (0.65 mm) and On-Resistance Per Footprint Area

### **APPLICATIONS**

• Smart Batteries for Portable Devices



<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25 \text{ °C}$ , unless otherwise noted							
Parameter		Symbol	5 s	Steady State	Unit		
Source1- Source2 Voltage		V <sub>S1S2</sub>	- 20		V		
Gate-Source Voltage		V <sub>GS</sub>	± 12				
	T <sub>A</sub> = 25 °C	I <sub>S1S2</sub>	- 4.4	- 3.5			
Continuous Source1- Source2 Current $(T_J = 150 \text{ °C})^a$	T <sub>A</sub> = 85 °C		- 3.2	- 2.5	А		
Pulsed Source1- Source2 Current		I <sub>SM</sub>	- 10				
Mariana Diata dia 4	T <sub>A</sub> = 25 °C	- P <sub>D</sub>	1.7	1	W		
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 85 °C		0.8	0.5	vv		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C		
Package Reflow Conditions <sup>c</sup>	IR/Convection		260				

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum humation to Ambianta	t ≤ 5 s	R <sub>thJA</sub>	60	75		
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		95	120	°C/W	
Maximum Junction-to-Foot <sup>b</sup>	Steady State	R <sub>thJF</sub>	18	22		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. The foot is defined as the top surface of the package.

c. Refer to IPC/JEDEC (J-STD-020C), no manual or hand soldering.



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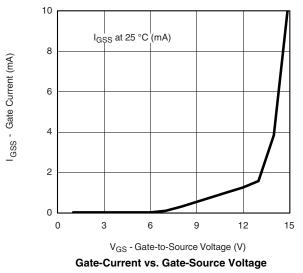
<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , unless otherwise noted								
Symbol	Test Conditions Min.		Тур.	Max.	Unit			
			•					
V <sub>GS(th)</sub>	$V_{SS} = V_{GS}$ , $I_D = -350 \ \mu A$	- 0.45		- 1.0	V			
	$V_{SS} = 0 V, V_{GS} = \pm 4.5 V$			± 4	μA			
GSS	$V_{SS} = 0 V, V_{GS} = \pm 12 V$			± 10	mA			
	$V_{SS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μA			
IS1S2	$V_{SS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$			- 5				
I <sub>S(on)</sub>	$V_{SS} = -5 V, V_{GS} = -4.5 V$	- 5			А			
	$V_{GS} = -4.5 \text{ V}, \text{ I}_{SS} = -1 \text{ A}$		0.048	0.060				
R <sub>S1S2(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>SS</sub> = - 1 A		0.062	0.080	Ω			
	V <sub>GS</sub> = - 1.8 V, I <sub>SS</sub> = - 1 A		0.081	0.105	1			
9 <sub>fs</sub>	V <sub>SS</sub> = - 10 V, I <sub>SS</sub> = - 1 A		7		S			
t <sub>d(on)</sub>			2.3	3.5				
t <sub>r</sub>	$V_{SS}$ = - 10 V, $R_L$ = 10 $\Omega$		2.2	3.5				
t <sub>d(off)</sub>	$\text{I}_{\text{SS}}\cong$ - 1 A, $\text{V}_{\text{GEN}}$ = - 4.5 V, $\text{R}_{\text{g}}$ = 6 $\Omega$		1.3	2	μs			
t <sub>f</sub>			9	14				
	Symbol   V <sub>GS</sub> (th)   I <sub>GSS</sub> I <sub>S1S2</sub> I <sub>S(on)</sub> R <sub>S1S2(on)</sub> gfs   t <sub>d(onf)</sub> t <sub>d(off)</sub>	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions \\ \hline \hline V_{GS}(th) & V_{SS} = V_{GS}, I_D = -350 \ \mu A \\ \hline V_{GS} = 0 \ V, \ V_{GS} = \pm 4.5 \ V \\ \hline V_{SS} = 0 \ V, \ V_{GS} = \pm 4.5 \ V \\ \hline V_{SS} = 0 \ V, \ V_{GS} = \pm 12 \ V \\ \hline V_{SS} = -20 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 0 \ V \\ \hline V_{SS} = -20 \ V, \ V_{GS} = 0 \ V, \ T_J = 85 \ ^\circ C \\ \hline I_{S(on)} & V_{SS} = -5 \ V, \ V_{GS} = -4.5 \ V \\ \hline V_{GS} = -4.5 \ V, \ I_{SS} = -1 \ A \\ \hline V_{GS} = -2.5 \ V, \ I_{SS} = -1 \ A \\ \hline V_{GS} = -1.8 \ V, \ I_{SS} = -1 \ A \\ \hline V_{GS} = -1.8 \ V, \ I_{SS} = -1 \ A \\ \hline I_{d(on)} & V_{SS} = -10 \ V, \ I_{SS} = -1 \ A \\ \hline I_{SS} = -10 \ V, \ I_{SS} = -1 \ A \\ \hline I_{SS} = -10 \ V, \ I_{SS} = -1 \ A \\ \hline V_{SS} = -10 \ V, \ I_{SS} = -10 \ V, \ I_{SS} = -1 \ A \\ \hline V_{SS} = -10 \ V, \ I_{SS} $	$\begin{array}{c c c c c c c c } Symbol & Test Conditions & Min. \\ \hline & & & & & & & & & & & & & & & & & &$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $			

Notes:

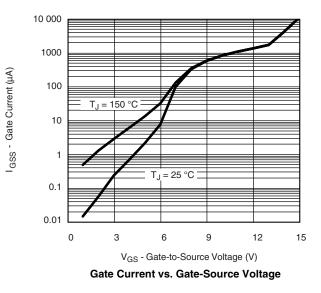
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

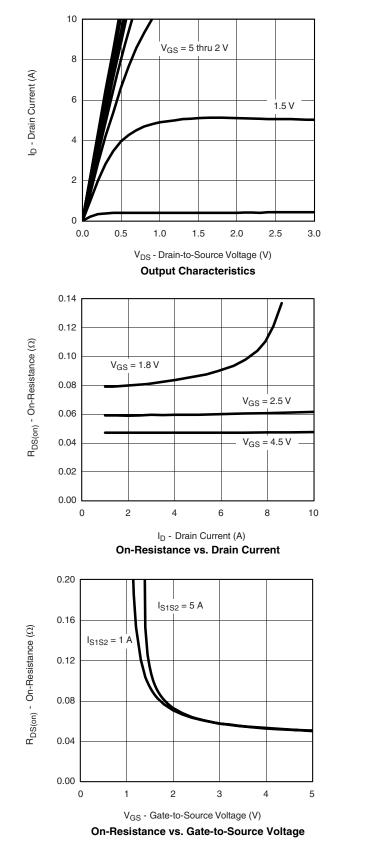


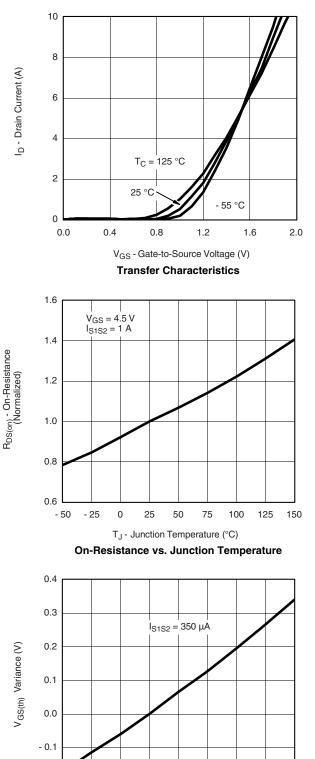


# Si8901EDB

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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





25

50

T<sub>J</sub> - Temperature (°C)

**Threshold Voltage** 

75

100

- 0.2

- 50

- 25

0

125

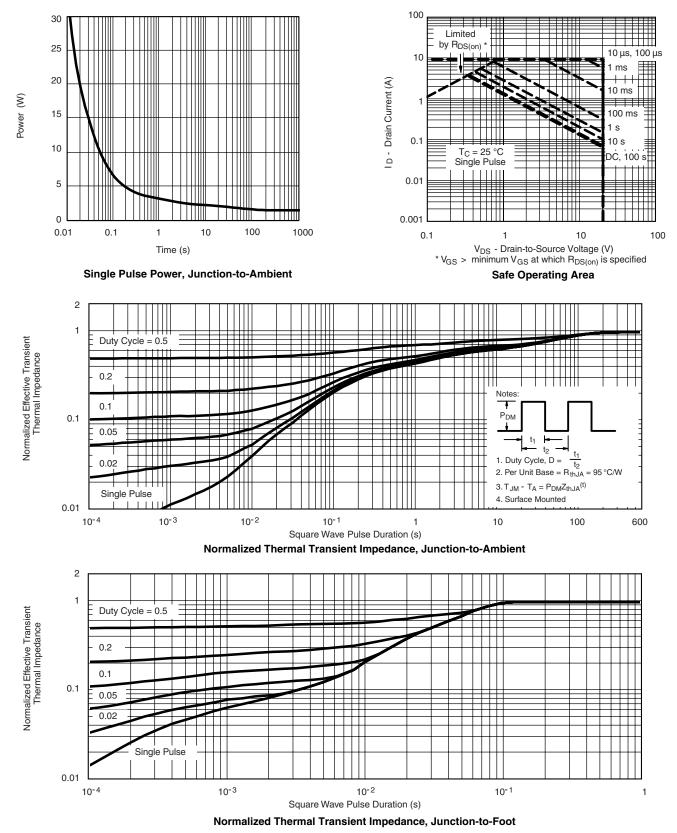
150

# Si8901EDB





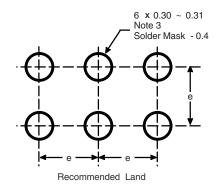
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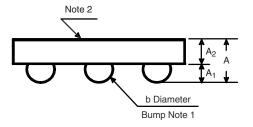


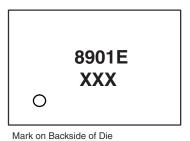


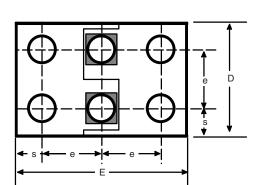
#### PACKAGE OUTLINE

#### MICRO FOOT: 6-BUMP (2 x 3, 0.8 mm PITCH)









Notes (Unless Otherwise Specified):

1. 6 solder bumps are 95.5/3.8/0.7 Sn/Ag/Cu.

2. Backside surface is coated with a Ag/Ni/Ti layer.

3. Non-solder mask defined copper landing pad.

4. Laser marks on the silicon die back.

Dim.	Millim	eters <sup>a</sup>	Inches		
	Min.	Max.	Min.	Max.	
Α	0.600	0.650	0.0236	0.0256	
A <sub>1</sub>	0.260	0.290	0.102	0.114	
A <sub>2</sub>	0.340	0.360	0.0134	0.0142	
b	0.370	0.410	0.0146	0.0161	
D	1.52	1.6	0.0598	0.0630	
E	2.32	2.4	0.0913	0.0945	
е	0.750	0.850	0.0295	0.0335	
s	0.380	0.400	0.0150	0.0157	

Notes:

a. Use millimeters as the primary measurement.

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